

1. Description

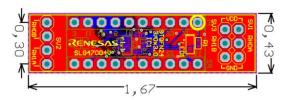
The GreenPAK DIP Adapter is a small PCB that lets you adapt STQFN packages into a DIP footprint. This board can speed up your design prototyping and testing. This small board 0.43x1.67 inch uses 20 pins DIP footprint with 0.3 inch width. You can also use this adapter for prototyping by making MSTQFN package compatible with solder free breadboards.

2. Features

Low cost

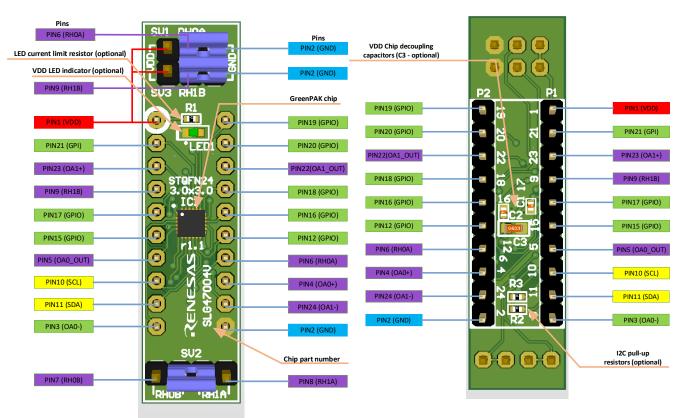
4. Bottom View

- Simplifies prototyping of SMT IC's
- Optional V_{DD} LED indicator
- · Decoupling capacitor included
- Optional I²C pull-up resistors



Note 1 All sizes in millimeters (mm).

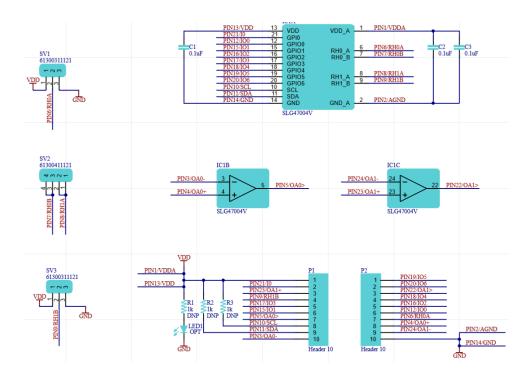
3. Top View



Revision 1.0



5. Board Schematic



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TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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